SiR167DP

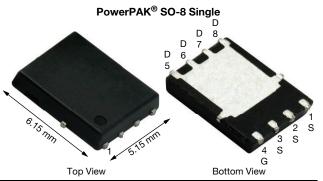
RoHS COMPLIANT

HALOGEN

FREE

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PRODUCT SUMMARY $V_{DS} \overline{(V)}$ -30 $R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V 0.0055 $R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V 0.0093 Qg typ. (nC) 36 **-60** a, g I_D (A) Configuration Single

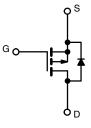
FEATURES

P-Channel 30 V (D-S) MOSFET

- TrenchFET[®] Gen III p-channel power MOSFET
- 100 % R_{α} and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Adapter and charger switch
- · Load switch
- Battery management



P-Channel MOSFET

ORDERING INFORMATION

Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiR167DP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-30		
Gate-source voltage		V _{GS}	± 25	V	
	T _C = 25 °C		-60 ª		
Continuous durin comment (T. 150.00)	T _C = 70 °C	1.	-60 ^a		
Continuous drain current ($T_J = 150 \text{ °C}$)	T _A = 25 °C	I _D	-23.8 ^{b, c}		
	T _A = 70 °C		-19.1 ^{b, c}	•	
Pulsed drain current (t = 100 µs)		I _{DM}	-120	A	
Orational and during diada anyment	T _C = 25 °C		-54.8		
Continuous source-drain diode current	T _A = 25 °C	I _S	-4.2 ^{b, c}		
Single pulse avalanche current		I _{AS}	-20		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	20	mJ	
	T _C = 25 °C 65.8				
Maniana a successibilities at the second	T _C = 70 °C		42.1	14/	
Maximum power dissipation	T _A = 25 °C	PD	5.1 ^{b, c}	W	
	T _A = 70 °C	1	3.2 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	*0	
Soldering recommendations (peak temperature) ^c			260	°C	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.5	1.9	0/10

Notes

a.

Package limited Surface mounted on 1" x 1" FR4 board b.

t = 10 s c.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 65 °C/W e.

f.

g. T_C = 25 °C

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Document Number: 76017

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See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

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SiR167DP

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = -10 mA	-	-25.8	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	4.2	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-2.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 25 V$	-	-	100	nA
Zere gete veltege drein eurrent	I _{DSS}	V_{DS} = -30 V, V_{GS} = 0 V	-	-	-1	
Zero gate voltage drain current		V_{DS} = -30 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	-15	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \geq$ -10 V, V_{GS} = -10 V	-30	-	-	Α
Drain-source on-state resistance ^a		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -15 \text{ A}$	-	0.0046	0.0055	Ω
Drain-source on-state resistance ~	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	-	0.0078 0.0	0.0093	52
Forward transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -20 A	-	60	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	4380	-	
Output capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	535	-	pF
Reverse transfer capacitance	C _{rss}		-	460	-	
Total acta charge	0	V_{DS} = -15 V, V_{GS} = -10 V, I_{D} = -23.8 A	-	74	111	nC
Total gate charge	Qg		-	36	54	
Gate-source charge	Q _{gs}	V_{DS} = -15 V, V_{GS} = -4.5 V, I_D = -23.8 A	-	12.1	-	
Gate-drain charge	Q _{gd}		-	12.3	-	
Gate resistance	Rg	f = 1 MHz	0.32	1.6	3.2	Ω
Turn-on delay time	t _{d(on)}		-	20	40	- ns
Rise time	t _r	V_{DD} = -15 V, R_L = 0.79 Ω , $I_D \cong$ -19.1 A,	-	25	50	
Turn-off delay time	t _{d(off)}	V_{GEN} = -10 V, R_g = 1 Ω	-	35	70	
Fall time	t _f		-	18	36	
Turn-on delay time	t _{d(on)}		-	25	50	
Rise time	t _r	V_{DD} = -15 V, R_L = 0.79 Ω , $I_D \cong$ -19.1 A,	-	25	50	
Turn-off delay time	t _{d(off)}	V_{GEN} = -4.5 V, R_g = 1 Ω	-	35	70	
Fall time	t _f		-	22	44	
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	IS	T _C = 25 °C	-	-	-54.8	A
Pulse diode forward current	I _{SM}		-	-	-120	A
Body diode voltage	V _{SD}	$I_{\rm S} = -5$ A, $V_{\rm GS} = 0$ V	-	-0.73	-1.2	V
Body diode reverse recovery charge	Q _{rr}		-	45	90	nC
Reverse recovery fall time	t _a	I _F = -19.1 A, di/dt = 100 A/μs,	-	19	-	
Reverse recovery rise time	t _b	T _J = 25 °C	-	22	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

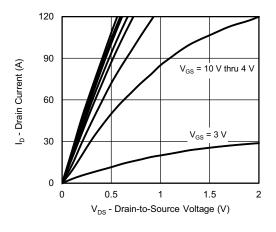
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

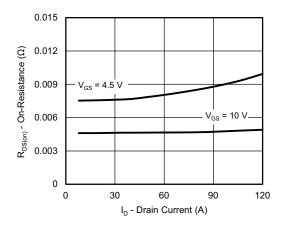


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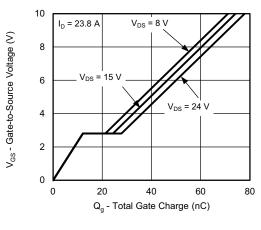
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



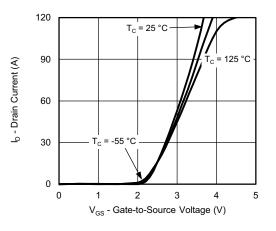
Output Characteristics



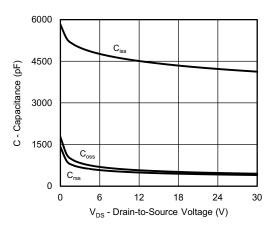
On-Resistance vs. Drain Current and Gate Voltage



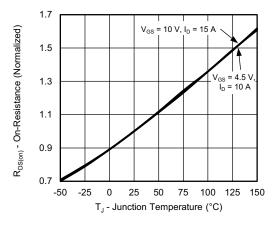
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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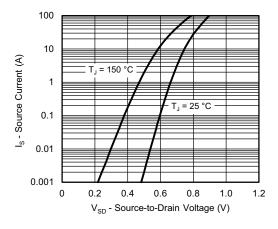
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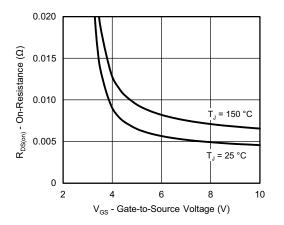


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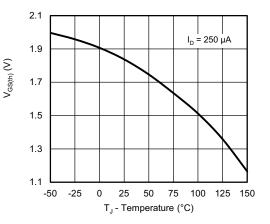
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



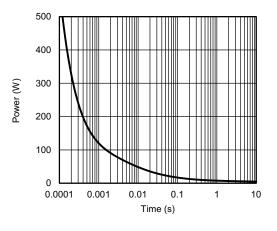
Source-Drain Diode Forward Voltage



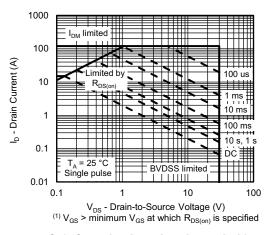
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

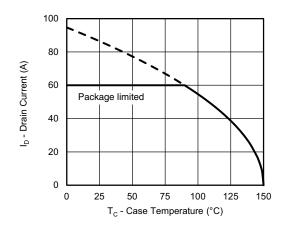
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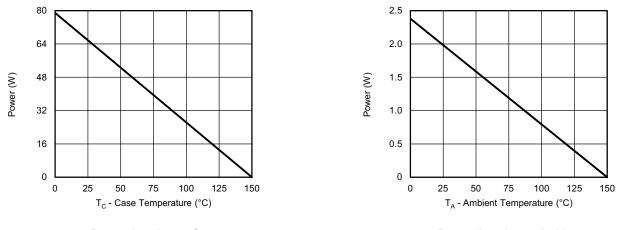


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power, Junction-to-Case

Power, Junction-to-Ambient

Note

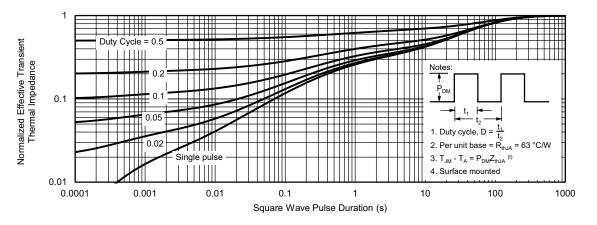
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



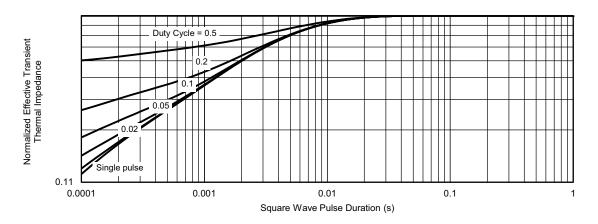
SiR167DP

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76017.

D2

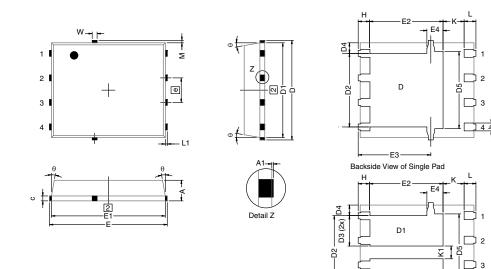
E3

Backside View of Dual Pad



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PowerPAK[®] SO-8, (Single/Dual)



Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
А	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.			0.0225 typ.		
D5		3.98 typ.			0.157 typ.		
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2	3.48	3.66	3.84	0.137	0.144	0.15 ⁻	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4		0.75 typ.		0.030 typ.		0.193 0.19 0.148 0.15 0.059 0.06 0.0225 typ. 0.157 typ. 0.157 typ. 0.242 0.232 0.23 0.144 0.15 0.149 0.15 0.030 typ. 0.050 BSC 0.050 typ. - 0.024 0.02 0.024 0.02	
е		1.27 BSC		0.030 typ.			
К		1.27 typ.					
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М		0.125 typ.			0.005 typ.		

1



Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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